





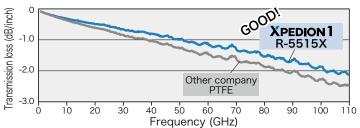
Laminate Prepreg R-5515X R-5410X

Halogen-free ultra-low transmission loss multi-layer circuit board materials

Prepreg R-5410X enables multi-layer antenna constructions and improves the design flexibility of high-frequency circuit boards; especially suitable for millimeter-wave antennas.

This material achieves higher efficiency and lower loss, with the added benefit of reduced processing costs.

Frequency dependence by transmission loss



Transmission loss at 77GHz

Material	Transmission loss (dB/inch)	Modeling Dk
XPEDION 1 R-5515X	-1.4	3.14
Other company PTFE	-1.8	3.13

Construction Microstrip line

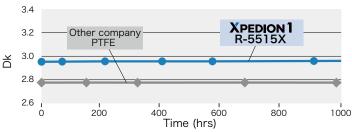


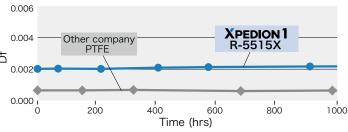
Measurement	2 port S-Parameter		
Frequency	10MHz-110GHz		
De-embedded	TRL method		
Measurement line	adjust to 50Ω(Zo)		

Layer1: Signal line (line width: $300\mu m$, Cu thickness: $24\mu m$) Layer2: GND plane (Cu thickness: 24 µm)

The above data are typical values and not guaranteed values.

Long-term stability under high temperature (Dk, Df)





- · Measurement method: Cavity resonator method
- · Aging temperature: 125°C (without humidity control)
- Measurement frequency: 10GHz

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General properties

Item		Test method	Condition	Unit	XPEDION 1 R-5515X
Tg		DMA	А	°C	200
CTE z-axis	α1	IPC-TM-650 2.4.24	А	ppm/°C	50*1
	α2	1 IPC-11VI-050 2.4.24			300*1
T288(with copper)		IPC-TM-650 2.4.24.1	А	min	>120*1
Dk	1.401.1-	Balanced-type circular	C-24/23/50	C-24/23/50 -	3.06
Df	14GHz	disk resonator method			0.0021
Peel strength*2	1/2oz(18µm)	IPC-TM-650 2.4.8	А	kN/m	0.6

The sample thickness is 0.13mm.
*1 The sample thickness is 0.5mm. *2 H-VLP2 Copper

Please see our website for Notes before you use

Please contact us about the thickness specification. Our Halogen-free materials are based on JPCA-ES-01-2003 standard and others.

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